

# **Final Product Change Notification**

202012007F01: NX5P3363UK FAB EXPANSION (SSMC TO TSMC10)

**Note:** This notice is NXP Company Proprietary.

Issue Date: Dec 18, 2020 Effective date:Mar 18, 2021

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#### **Management summary**

In order to secure the customer delivery and fab capacity, enable TSMC10 to support NX5P3363UK manufacturing as 2nd source.

### **Change Category**

| [ ]Water<br>Fab<br>Process  | []Assembly<br>Process   | []Product Marking           | []Test<br>Process   | []Design                               |
|-----------------------------|-------------------------|-----------------------------|---------------------|--|
| []Wafer<br>Fab<br>Materials | []Assembly<br>Materials | []Mechanical Specification  | []Test<br>Equipment | []Errata                               |
| [X]Wafer<br>Fab<br>Location | []Assembly<br>Location  | []Packing/Shipping/Labeling | []Test<br>Location  | []Electrical<br>spec./Test<br>coverage |
| []Firmware                  | []Other                 |                             |                     |  |

# **PCN Overview**

# **Description**

NXP Semiconductors is announcing the introduction of Taiwan Semiconductor Manufacturing Company Fab 10 (TSMC10), Shanghai, China as a dual source wafer manufacturing location for the NX5P3290 (WLCSP16).

### Reason

The Fab manufacturing site capacity expansion to TSMC10 will improve NXP's ability to meet increasing customer demand and still maintain supply from the original Fab (SSMC).

### **Identification of Affected Products**

**Top Side Marking** 

The Line C of the Mask ID marking will change from ZtDYYWW to NtDYYWW. 'Z' for SSMC; 'N' for TSMC10

# **Product Availability**

#### **Sample Information**

Samples are available upon request

#### **Production**

Planned first shipment Jan 31, 2021

## Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

**Data Sheet Revision** 

No impact to existing datasheet

**Disposition of Old Products** 

Fab Expansion. No Depletion of Inventory required.

## **Timing and Logistics**

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by Jan 17, 2021.

### Remarks

NX5P3363UK TSMC10 reliability test finished and pass.

### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

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NXP Quality Management Team.

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High Tech Campus, 5656 AG Eindhoven, The Netherlands

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#### **Affected Part Number**

NX5P3363UKZ